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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
10/757,388	01/15/2004	Takeshi Kobayashi	61282-055 4950		
7590 05/04/2006			EXAMINER		
McDERMOTT, WILL & EMERY			NGUYEN, DILINH P		
600 13th Street, N.W. Washington, DC 20005-3096			ART UNIT	PAPER NUMBER	
			. 2814		
			DATE MAILED: 05/04/2000	6	

Please find below and/or attached an Office communication concerning this application or proceeding.

1		Application	No.	Applicant(s)	_				
Office Action Summary		10/757,388		KOBAYASHI ET AL.					
		Examiner		Art Unit					
		DiLinh Nguy		2814					
	The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply								
WHIC - Exter after - If NO - Failu Any r	ORTENED STATUTORY PERIOD FOR REP CHEVER IS LONGER, FROM THE MAILING asions of time may be available under the provisions of 37 CFR 1 SIX (6) MONTHS from the mailing date of this communication. Or period for reply is specified above, the maximum statutory perior are to reply within the set or extended period for reply will, by staturely received by the Office later than three months after the mailed patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS .136(a). In no even d will apply and will tte, cause the applic	S COMMUNICATION I, however, may a reply be time expire SIX (6) MONTHS from ation to become ABANDONEI	. ely filed the mailing date of this communication. D (35 U.S.C. § 133).					
Status									
1)⊠	Responsive to communication(s) filed on 14	February 2006	<u>5</u> .						
2a)⊠	This action is FINAL . 2b) Th	is action is no	n-final.						
3) 🗌	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is								
	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.								
Dispositi	ion of Claims								
4) 🖂	Claim(s) 1-3,5,19 and 20 is/are pending in th	e application.							
	4a) Of the above claim(s) is/are withdo	awn from con	sideration.						
5) 🗌	5) Claim(s) is/are allowed.								
6)⊠	Claim(s) <u>1-3,5,19 and 20</u> is/are rejected.								
7)	• • • • • • • • • • • • • • • • • • • •	4							
8)	Claim(s) are subject to restriction and	or election re	quirement.						
Applicat	ion Papers								
9)[The specification is objected to by the Exami	ner.							
10)	The drawing(s) filed on is/are: a) a	ccepted or b)	ceil objected to by the $ m I$	Examiner.					
	Applicant may not request that any objection to the								
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).									
11)	The oath or declaration is objected to by the	Examiner. Not	e the attached Office	Action or form PTO-152.					
Priority (under 35 U.S.C. § 119		•						
12)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).									
•	⊠ All b) Some * c) None of:								
	1. Certified copies of the priority documents have been received.								
	2. Certified copies of the priority documents have been received in Application No								
	3. Copies of the certified copies of the pr			ed in this National Stage					
	application from the International Bure	•							
* See the attached detailed Office action for a list of the certified copies not received.									
				•					
Attachment(s)									
	ce of References Cited (PTO-892)		4) Interview Summary						
	ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/0	18)	Paper No(s)/Mail Da 5) Notice of Informal F	ate Patent Application (PTO-152)					
	er No(s)/Mail Date	,	6)						

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Persuant to telephone interview dated 4/27/06 with Mr. Ramyar M. Farid, it was agreed the finality of the previous office action is improper and a corrected office action is set forth below.

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-3, 5 and 19-20 are rejected under 35 U.S.C. 102(b) as being anticipated by Ooyama et al. (U.S. Pat. 6191494).
 - Regarding claim 1, Ooyama et al. disclose a lead frame comprising:
 a lead frame body 31 comprising a sheet-shaped body made of metal [Cu] (fig.
 5A, column 6, lines 2-3);
 - a groove portion 33b for forming a lead which is formed by a predetermined depth in a lead forming region on a surface of the lead frame body; and a lead 28b having a portion which protrudes from the groove portion laterally onto the surface of the lead frame body, the lead being made of material [Ni or Pd] (fig. 5E, column 7, lines 17-20) different from material of the lead frame body (fig. 5E).
 - Regarding claim 2, Ooyama et al. disclose that the lead including: a first conductor layer 28a-2 formed in the groove portion; a second conductor layer

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28b-1 formed on the first conductor layer; and a third conductor layer 28b-2 formed on the second conductor layer; wherein the first conductor layer is assembled to an assembling member, and the third conductor layer 28b-2 is assembled to a bonding pad of a semiconductor chip (fig. 6).

- Regarding claim 3, Ooyama et al. disclose that wherein the first conductor layer covers an entire inner wall of the groove portion (fig. 6).
- Regarding claim 5, Ooyama et al. disclose that the lead includes a barrier layer [Au layer 28a-1] for suppressing a reaction between the lead frame body and the first conductor layer, the barrier layer being provided between the first conductor layer and the groove portion (figs. 5G and 6).
- Regarding claim 19, Ooyama et al. disclose a semiconductor device comprising:
 a semiconductor chip;

a multi-layer lead connected to the semiconductor chip and having a first conductor layer 28a (fig. 5C);

a piece of sealing resin 23; wherein a portion of the reverse face of the multilayer lead protrudes from a principal plane of the piece of sealing resin 23, the first conductor layer 28a covering an entire surface of the portion (fig. 5H, column 6, lines 20-30).

Regarding claim 20, Ooyama et al. disclose that the multi-layer lead further including: a second conductor layer 28a-2 laminated inside the first conductor layer 28a-1; and a third conductor layer 28b-1 formed inside the second conductor layer (fig. 6).

Conclusion

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DiLinh Nguyen whose telephone number is (571) 272-1712. The examiner can normally be reached on 8:00AM - 6:00PM (M-F).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

DLN

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